

# FAN4174/FAN4274 Single and Dual Ultra-Low Cost, Rail-to-Rail I/O, CMOS Amplifiers

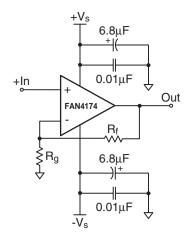
#### **Features**

- 200µA supply current per amplifier
- 3.7MHz bandwidth
- Output swing to within 10mV of either rail
- Input voltage range exceeds the rails
- 3V/µs slew rate
- 25nV/√Hz input voltage noise
- Replaces KM4170 and KM4270
- FAN4174 competes with OPA340 and TLV2461; available in lead (Pb) free SC70-5 and SOT23-5 packages
- FAN4274 competes with OPA2340 and TLV2462; available in lead (Pb) free MSOP-8 package
- Fully specified at +2.7V and +5V supplies

# **Applications**

- Portable/battery-powered applications
- PCMCIA, USB
- Mobile communications, cellular phones, pagers
- Notebooks and PDA's
- Sensor interface
- A/D buffer
- Active filters
- Signal conditioning
- Portable test instruments

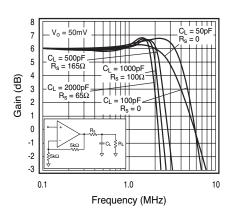
# **Typical Application Diagram**



# **Description**

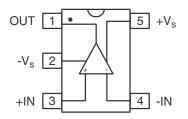
The FAN4174 (single) and FAN4274 (dual) are ultra-low cost, voltage feedback amplifiers with CMOS inputs that consume only  $200\mu A$  of supply current per amplifier while providing  $\pm 33 \text{mA}$  of output short circuit current. These amplifiers are designed to operate from 2.5V to 5V supplies. The common mode voltage range extends beyond the negative and positive rails

The FAN4174 and FAN4274 are designed on a CMOS process and provide 3.7MHz of bandwidth and 3V/µs of slew rate at a supply voltage of 5V. The combination of low power, rail-to-rail performance, low voltage operation, and tiny package options make this amplifier family well suited for use in many general purpose and battery powered applications.

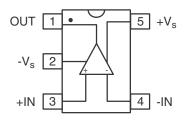


# **FAN4174 Pin Configurations**

### SOT23



# SC70

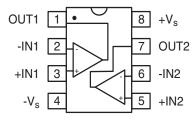


# **FAN4174 Pin Assignments**

Pin#	Pin	Description		
1	OUT	Output		
2	-Vs	Negative Supply		
3	+IN	Positive Supply		
4	-IN	Negative Input		
5	+Vs	Positive Supply		

# **FAN4274 Pin Configuration**

### MSOP-8



# **FAN4274 Pin Assignments**

Pin#	Pin	Description		
1	OUT1	Output, Channel 1		
2	-IN1	Negative Input, Channel 1		
3	+IN1	Positive Input, Channel 1		
4	-Vs	Negative Supply		
5	+IN2	Positive Input, Channel 2		
6	-IN2	Negative Input, Channel 2		
7	OUT2	Output, Channel 2		
8	+Vs	Positive Supply		

# **Reliability Information**

Parameter	Min.	Тур.	Max.	Unit
Junction Temperature			150	°C
Storage Temperature Range	-65		+150	°C
Lead Temperature (Soldering, 10s)			+300	°C
Thermal Resistance ( $\theta_{JA}$ ), 5 Lead SOT23 <sup>1</sup>		256		°C/W
Thermal Resistance ( $\theta_{JA}$ ), 5 Lead SC70 <sup>1</sup>		331		°C/W
Thermal Resistance (θ <sub>JA</sub> ), 8 Lead MSOP <sup>1</sup>		206		°C/W

#### Note:

1. Package thermal resistance  $(\theta_{\text{JA}})$ , JEDEC standard, multi-layer test boards, still air.

# **Absolute Maximum Ratings**

Parameter	Min.	Max.	Unit
Supply Voltage	0	6	V
Input Voltage Range	-V <sub>s</sub> -0.5	+V <sub>s</sub> +0.5	V

#### Note:

Functional operation under any of these conditions is NOT implied. Performance and reliability are guaranteed only if operating conditions are not exceeded.

# **Recommended Operating Conditions**

Parameter	Min.	Тур.	Max.	Unit
Operating Temperature Range	-40		+85	°C

# **Electrical Specifications at +2.7V**

. (V<sub>S</sub> = +2.7V, G = 2, R<sub>L</sub> = 10k $\Omega$  to V<sub>S</sub>/2, R<sub>F</sub> = 5k $\Omega$ ; unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
	Frequency Domain Response					
UGBW	-3dB Bandwidth	G = +1		4		MHz
BW <sub>SS</sub>	-3dB Bandwidth			2.5		MHz
GBWP	Gain Bandwidth product			4		MHz
	Time Domain Response					
t <sub>R</sub> , t <sub>F</sub>	Rise and Fall Time	V <sub>o</sub> = 1.0V step		300		ns
OS	Overshoot	V <sub>o</sub> = 1.0V step		5		%
SR	Slew Rate	V <sub>o</sub> = 3V step, G = -1		3		V/µs
	Distortion and Noise Response					
HD2	2nd Harmonic Distortion	$V_0 = 1V_{pp}$ , 10kHz		-66		dBc
HD3	3rd Harmonic Distortion	V <sub>o</sub> =1V <sub>pp</sub> , 10kHz		-67		dBc
THD	Total Harmonic Distortion	V <sub>o</sub> =1V <sub>pp</sub> , 10kHz		0.1		%
e <sub>n</sub>	Input Voltage Noise			26		nV/√Hz
X <sub>TALK</sub>	Crosstalk (FAN4274)	100kHz		-100		dB
	DC Performance					
V <sub>IO</sub>	Input Offset Voltage <sup>1</sup>		-6	0	+6	mV
dV <sub>IO</sub>	Average Drift			2.1		μV/°C
I <sub>bn</sub>	Input Bias Current			5		pА
PSRR	Power Supply Rejection Ratio <sup>1</sup>	DC	50	73		dB
A <sub>OL</sub>	Open Loop Gain	DC		98		dB
I <sub>S</sub>	Supply Current Per Amplifier <sup>1</sup>			200	300	μΑ
	Input Characteristics					
R <sub>IN</sub>	Input Resistance			10		GΩ
C <sub>IN</sub>	Input Capacitance			1.4		pF
CMIR	Input Common Mode Voltage Range	typical (FAN4174)		-0.3 to 2.6		V
		typical (FAN4274)		-0.3 to 3.0		V
CMRR	Common Mode Rejection Ratio <sup>1</sup>	DC, V <sub>CM</sub> = 0V to 2.2V for FAN4174	50	65		dB
		DC, $V_{CM} = 0V$ to 2.7V for FAN4274	50	65		dB
	Output Characteristics					
V <sub>O</sub>	Output Voltage Swing <sup>1</sup>	$R_L = 10k\Omega$ to $V_S/2$	0.03	0.01 to 2.69	2.65	V
		$R_L = 1k\Omega$ to $V_S/2$		0.05 to 2.55		V
I <sub>SC</sub>	Short Circuit Output Current			+34/-12		mA
V <sub>S</sub>	Power Supply Operating Range			2.5 to 5.5		V

# Notes:

1. 100% tested at 25°C.

# **Electrical Specifications at +5V**

(V<sub>S</sub> = +5V, G = 2, R<sub>L</sub> =  $10k\Omega$  to V<sub>S</sub>/2, R<sub>F</sub> =  $5k\Omega$ ; unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
	Frequency Domain Response					
UGBW	-3dB Bandwidth	G = +1		3.7		MHz
BW <sub>SS</sub>	-3dB Bandwidth			2.3		MHz
GBWP	Gain Bandwidth product			3.7		MHz
	Time Domain Response					
t <sub>R</sub> , t <sub>F</sub>	Rise and Fall Time	V <sub>o</sub> = 1.0V step		300		ns
OS	Overshoot	V <sub>o</sub> = 1.0V step		5		%
SR	Slew Rate	V <sub>o</sub> = 3V step, G = -1		3		V/µs
	Distortion and Noise Response					
HD2	2nd Harmonic Distortion	$V_0 = 1V_{pp}$ , $10kHz$		-80		dBc
HD3	3rd Harmonic Distortion	$V_0 = 1V_{pp}$ , $10kHz$		-80		dBc
THD	Total Harmonic Distortion	$V_0 = 1V_{pp}$ , $10kHz$		0.02		%
e <sub>n</sub>	Input Voltage Noise			25		nV/√Hz
X <sub>TALK</sub>	Crosstalk (FAN4274)	100kHz		-100		dB
	DC Performance					
V <sub>IO</sub>	Input Offset Voltage <sup>1</sup>		-8	0	+8	mV
dV <sub>IO</sub>	Average Drift			2.9		μV/°C
I <sub>bn</sub>	Input Bias Current			5		pА
PSRR	Power Supply Rejection Ratio <sup>1</sup>	DC	50	73		dB
A <sub>OL</sub>	Open Loop Gain	DC		102		dB
I <sub>S</sub>	Supply Current Per Amplifier <sup>1</sup>			200	300	μА
	Input Characteristics					
R <sub>IN</sub>	Input Resistance			10		GΩ
C <sub>IN</sub>	Input Capacitance			1.2		pF
CMIR	Input Common Mode Voltage Range	typical		-0.3 to 5.3		V
CMRR	Common Mode Rejection Ratio <sup>1</sup>	DC, $V_{CM} = 0V$ to $V_{S}$	58	73		dB
	Output Characteristics					
V <sub>O</sub>	Output Voltage Swing <sup>1</sup>	$R_L = 10k\Omega$ to $V_S/2$	0.03	0.01 to 4.99	4.95	V
		$R_L = 1k\Omega$ to $V_S/2$		0.1 to 4.9		V
I <sub>SC</sub>	Short Circuit Output Current			±33		mA
V <sub>S</sub>	Power Supply Operating Range			2.5 to 5.5		V

## Notes:

1. 100% tested at 25°C.

Typical Performance Characteristics ( $V_S$  = +2.7, G = 2,  $R_L$  = 10k $\Omega$  to  $V_S$ /2,  $R_F$  = 5k $\Omega$ ; unless otherwise noted)

Figure 1. Non-Inverting Freq. Response (+5V)

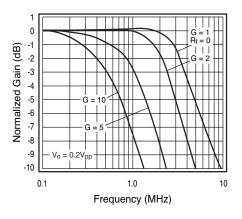


Figure 3. Non-Inverting Freq. Response

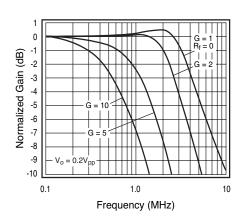


Figure 5. Frequency Response vs. C<sub>L</sub>

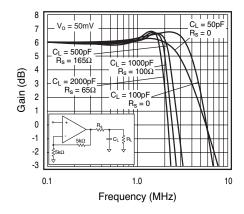


Figure 2. Inverting Freq. Response (+5V)

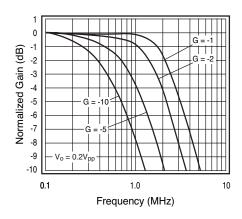


Figure 4. Inverting Freq. Response

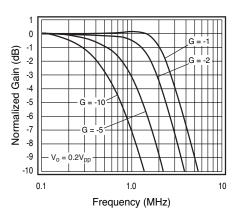
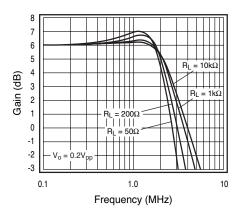


Figure 6. Frequency Response vs. R<sub>L</sub>



Typical Performance Characteristics ( $V_S$  = +2.7V, G = 2,  $R_L$  = 10k $\Omega$  to  $V_S/2$ ,  $R_F$  = 5k $\Omega$ ; unless otherwise noted)

Figure 7. Large Signal Freq. Response (+5V)

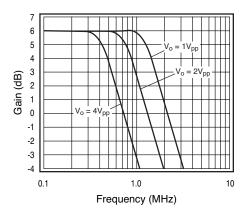


Figure 9. 2nd & 3rd Harmonic Distortion

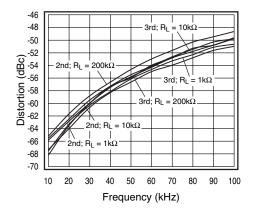


Figure 11. 3rd Harmonic Distortion vs. Vo

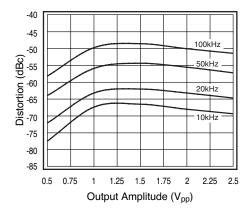


Figure 8. Open Loop Gain and Phase vs. Freq.

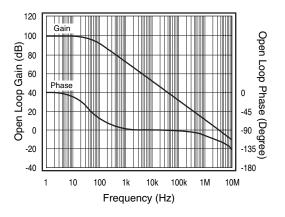


Figure 10. 2nd Harmonic Distortion vs. Vo

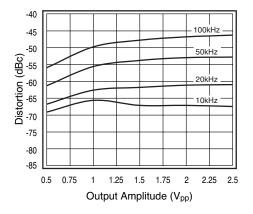
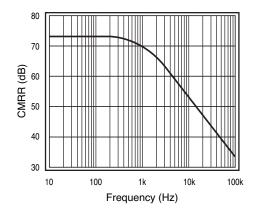


Figure 12. CMRR  $V_s = 5V$ 



Typical Performance Characteristics ( $V_S$  = +2.7V, G = 2,  $R_L$  = 10k $\Omega$  to  $V_S/2$ ,  $R_F$  = 5k $\Omega$ ; unless otherwise noted)

Figure 13. PSRR  $V_s = 5V$ 

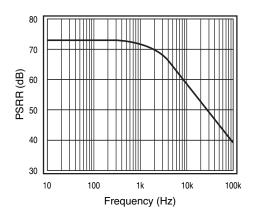


Figure 14. Output Swing vs. Load

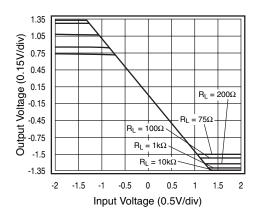


Figure 15. Pulse Resp. vs. Common Mode Voltage

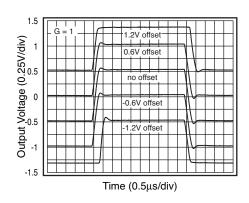
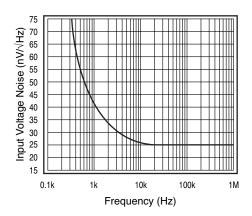


Figure 16. Input Voltage Noise



# **Application Information**

# **General Description**

The FAN4174 amplifier family are single supply, general purpose, voltage-feedback amplifiers. Fabricated on a bi-CMOS process. The family features a rail-to-rail input and output and is unity gain stable.

The typical non-inverting circuit schematic is shown in Figure 1.

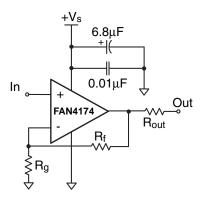


Figure 1. Typical Non-inverting Configuration

# Input Common Mode Voltage

The common mode input range extends to 300mV below ground and to 100mV above Vs, in single supply operation. Exceeding these values will not cause phase reversal. However, if the input voltage exceeds the rails by more than 0.5V, the input ESD devices will begin to conduct. The output will stay at the rail during this overdrive condition. If the absolute maximum input voltage (700mV beyond either rail) is exceeded, externally limit the input current to ±5mA as shown in Figure 2.

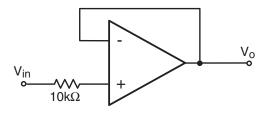


Figure 2. Circuit for Input Current Protection

## **Power Dissipation**

The maximum internal power dissipation allowed is directly related to the maximum junction temperature. If the maximum junction temperature exceeds 150°C, some performance degradation will occur. If the maximum junction temperature exceeds 150°C for an extended time, device failure may occur.

# **Overdrive Recovery**

Overdrive of an amplifier occurs when the output and/or input ranges are exceeded. The recovery time varies based on whether the input or output is overdriven and by how much the ranges are exceeded. The FAN4174 will typically recover in less than 500ns from an overdrive condition.

Figure 3 shows the FAN4174 amplifier in an overdriven condition.

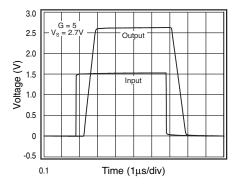


Figure 3. Overdrive Recovery

# **Driving Capacitive Loads**

The Frequency Response vs.  $C_L$  plot, illustrates the response of the FAN4174 amplifier family. A small series resistance ( $R_s$ ) at the output of the amplifier, illustrated in Figure 4, will improve stability and settling performance.  $R_s$  values in the Frequency Response vs.  $C_L$  plot were chosen to achieve maximum bandwidth with less than 2dB of peaking. For maximum flatness, use a larger  $R_s$ . Capacitive loads larger than 500pF require the use of  $R_s$ .

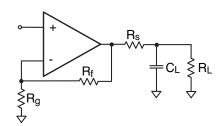


Figure 4. Typical Topology for driving a capacitive load

Driving a capacitive load introduces phase-lag into the output signal, which reduces phase margin in the amplifier. The unity gain follower is the most sensitive configuration. In a unity gain follower configuration, the FAN4174 amplifier family requires a  $300\Omega$  series resistor to drive a 100pF load.

# **Layout Considerations**

General layout and supply bypassing play major roles in high frequency performance. Fairchild has evaluation boards to use as a guide for high frequency layout and as an aid in device testing and characterization. Follow the steps below as a basis for high frequency layout:

- Include 6.8μF and 0.01μF ceramic capacitors
- Place the 6.8μF capacitor within 0.75 inches of the power pin
- Place the 0.01μF capacitor within 0.1 inches of the power pin
- Remove the ground plane under and around the part, especially near the input and output pins to reduce parasitic capacitance
- · Minimize all trace lengths to reduce series inductances

Refer to the evaluation board layouts shown in Figure 6 for more information.

When evaluating only one channel, complete the following on the unused channel:

- 1. Ground the non-inverting input
- 2. Short the output to the inverting input

# **Evaluation Board Information**

The following evaluation boards are available to aid in the testing and layout of this device:

Eval Bd	Description	Products
KEB002	Single Channel, Dual Supply, 5 and 6 lead SOT23	FAN4174IS5X
KEB010	Dual Channel, Dual Supply 8 lead MSOP	FAN4274IMU8X
KEB011	Single Channel, Dual Supply, 5 and 6 lead SC70	FAN4174IP5X

Evaluation board schematics are shown in Figures 5a and 5b, layouts are shown in Figure 6a through 6d.

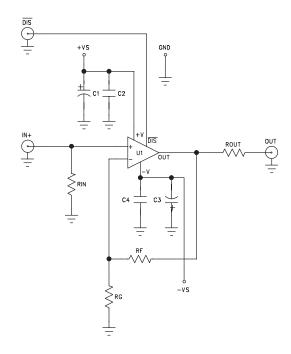


Figure 5a. FAN4174 Evaluation Board Schematic (KEB002/KEB011)

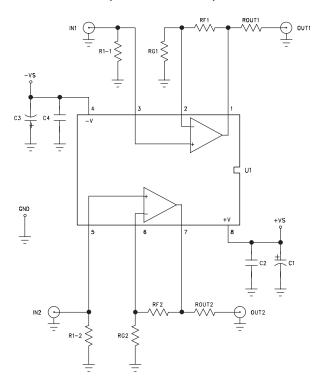


Figure 5b. FAN4274 Evaluation Board Schematic (KEB010)

# KOTA LAYER1 SILK

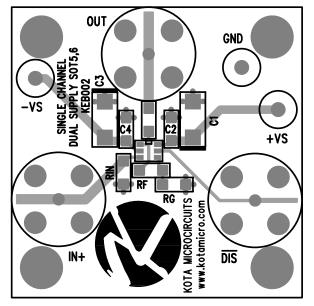


Figure 6a: KEB002 (top side)

**KOTA LAYER2 SILK** 

KOTA LAYER2

Figure 6b: KEB002 (bottom side)

# KOTA LAYER1 SILK

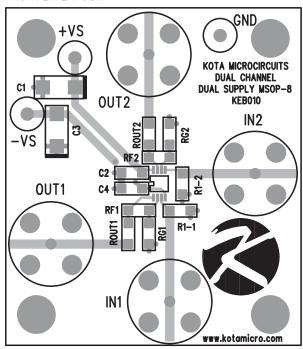
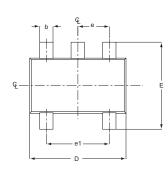


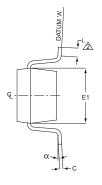
Figure 6c: KEB010 (top side)

Figure 6d: KEB010 (bottom side)

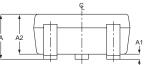
# **Mechanical Dimensions**

# **SOT-23**





SYMBOL	MIN	MAX	
Α	0.90	1.45	
A1	0.00	0.15	
A2	0.90	1.30	
b	0.25	0.50	
С	0.09	0.20	
D	2.80	3.10	
E	2.60	3.00	
E1	1.50	1.75	
L	0.35	0.55	
е	0.95 ref		
e1	1.90 ref		
α	0°	10°	



#### NOTE:

- NOTE:

  1. All dimensions are in millimeters.

  2. Foot length measured reference to flat foot surface parallel to DATUM 'A' and lead surface.

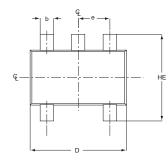
  3. Package outline exclusive of mold flash & metal burr.

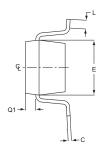
  4. Package outline inclusive of solder plating.

  5. Comply to EIAJ SC74A.

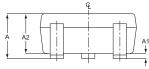
  6. Package ST 0003 REV A supercedes SOT-D-2005 REV C.

# **SC70**





SYMBOL	MIN	MAX
е	0.65	BSC
D	1.80	2.20
b	0.15	0.30
Е	1.15	1.35
HE	1.80	2.40
Q1	0.10	0.40
A2	0.80	1.00
A1	0.00	0.10
Α	0.80	1.10
С	0.10	0.18
L	1.10	0.30



## NOTE:

- NOTE:

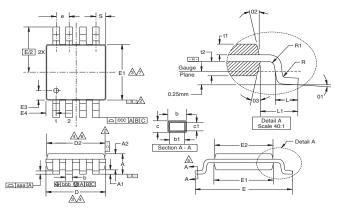
  1. All dimensions are in millimeters.

  2. Dimensions are inclusive of plating.

  3. Dimensions are exclusive of mold flashing and metal burr.

  4. All specufications comply to EIAJ SC70.

## **MSOP**



MSOP-8					
SYMBOL	MIN	MAX			
Α	1.10	-			
A1	0.10	0.05			
A2	0.86	0.08			
D	3.00	0.10			
D2	2.95	0.10			
E	4.90	0.15			
E1	3.00	0.10			
E2	2.95	0.10			
E3	0.51	0.13			
E4	0.51	0.13			
R	0.15	+0.15/-0.0			
R1	0.15	+0.15/-0.0			
t1	0.31	0.08			
t2	0.41	0.08			
b	0.33	+0.07/-0.0			
b1	0.30	0.05			
С	0.18	0.05			
c1	0.15	+0.03/-0.0			
01	3.0	3.0			
02	12.0	3.0			
03	12.0	3.0			
L	0.55	0.15			
L1	0.95 BSC	-			
aaa	0.10	-			
bbb	0.08	-			
ccc	0.25	-			
е	0.65 BSC	-			
S	0.525 BSC	-			

# NOTE:

# **Ordering Information**

Model	Part Number	Lead Free	Package	Container	Pack Qty.
FAN4174	FAN4174IS5X_NL	Yes	SOT23-5	Reel	3000
FAN4174	FAN4174IP5X_NL	Yes	SC70-5	Reel	3000
FAN4274	FAN4274IMU8X	Yes	MSOP-8	Reel	3000

Temperature Range: -40°C to +85°C

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# PRODUCT STATUS DEFINITIONS

### **Definition of Terms**

Datasheet Identification	Product Status	Definition
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Rev. I15